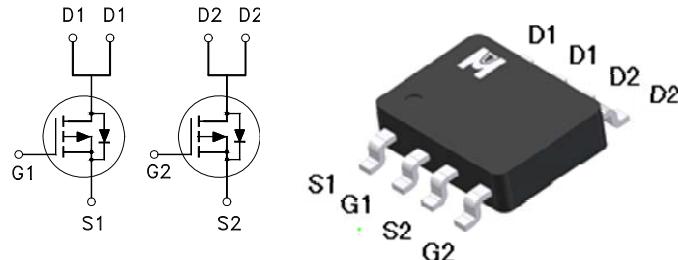


Dual P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

|                     |              |
|---------------------|--------------|
| $BV_{DSS}$          | -30V         |
| $R_{DS(on)}$ (MAX.) | 24m $\Omega$ |
| $I_D$               | -8A          |



UIS,  $R_g$  100% Tested

Pb-Free Lead Plating



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$  Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS                     |  | SYMBOL         | LIMITS     | UNIT |
|--|--|----------------|------------|------|
| Gate-Source Voltage                            |  | $V_{GS}$       | $\pm 25$   | V    |
| Continuous Drain Current                       | $T_C = 25^\circ C$                     | $I_D$          | -8         | A    |
|  | $T_C = 100^\circ C$                    |                | -6         |      |
| Pulsed Drain Current <sup>1</sup>              |  | $I_{DM}$       | -32        |      |
| Avalanche Current                              |  | $I_{AS}$       | -12        |      |
| Avalanche Energy                               | $L = 0.1mH, I_D = -8A, R_G = 25\Omega$ | $E_{AS}$       | 3.2        | mJ   |
| Repetitive Avalanche Energy <sup>2</sup>       | $L = 0.05mH$                           | $E_{AR}$       | 1.6        |      |
| Power Dissipation                              | $T_A = 25^\circ C$                     | $P_D$          | 2          | W    |
|  | $T_A = 100^\circ C$                    |                | 1.1        |      |
| Operating Junction & Storage Temperature Range |  | $T_j, T_{stg}$ | -55 to 150 | °C   |

100% UIS testing in condition of  $V_D = -15V$ ,  $L = 0.1mH$ ,  $V_G = -10V$ ,  $I_L = -8A$ , Rated  $V_{DS} = -30V$  P-CH

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE               | SYMBOL          | TYPICAL | MAXIMUM | UNIT   |
|----------------------------------|-----------------|---------|---------|--------|
| Junction-to-Case                 | $R_{\theta JC}$ | 25      | 62.5    | °C / W |
| Junction-to-Ambient <sup>3</sup> | $R_{\theta JA}$ |         |         |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle  $\leq 1\%$

<sup>3</sup>62.5°C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , Unless Otherwise Noted)

| PARAMETER   | SYMBOL                      | TEST CONDITIONS   | LIMITS |      |           | UNIT             |
|---|-----------------------------|---|--------|------|-----------|------------------|
|   |                             |   | MIN    | TYP  | MAX       |                  |
| STATIC  |                             |   |        |      |           |                  |
| Drain-Source Breakdown Voltage  | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0V, I_D = -250\mu\text{A}$                          | -30    |      |           | V                |
| Gate Threshold Voltage  | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = -250\mu\text{A}$                      | -1     | -1.5 | -3        |                  |
| Gate-Body Leakage   | $I_{GSS}$                   | $V_{DS} = 0V, V_{GS} = \pm 20V$                               |        |      | $\pm 100$ | nA               |
|   |                             | $V_{DS} = 0V, V_{GS} = \pm 25V$                               |        |      | $\pm 500$ |                  |
| Zero Gate Voltage Drain Current   | $I_{DSS}$                   | $V_{DS} = -24V, V_{GS} = 0V$                                  |        |      | -1        | $\mu\text{A}$    |
|   |                             | $V_{DS} = -20V, V_{GS} = 0V, T_J = 125^\circ\text{C}$         |        |      | -10       |                  |
| On-State Drain Current <sup>1</sup>   | $I_{D(\text{ON})}$          | $V_{DS} = -5V, V_{GS} = -10V$                                 | -8     |      |           | A                |
| Drain-Source On-State Resistance <sup>1</sup>                               | $R_{DS(\text{ON})}$         | $V_{GS} = -10V, I_D = -8A$                                    |        | 20.5 | 24        | $\text{m}\Omega$ |
|   |                             | $V_{GS} = -4.5V, I_D = -6A$                                   |        | 29   | 37        |                  |
| Forward Transconductance <sup>1</sup>                                       | $g_{fs}$                    | $V_{DS} = -5V, I_D = -8A$                                     |        | 24   |           | S                |
| DYNAMIC   |                             |   |        |      |           |                  |
| Input Capacitance   | $C_{iss}$                   | $V_{GS} = 0V, V_{DS} = -15V, f = 1\text{MHz}$                 |        | 1407 |           |                  |
| Output Capacitance  | $C_{oss}$                   |   |        | 208  |           | pF               |
| Reverse Transfer Capacitance  | $C_{rss}$                   |   |        | 164  |           |                  |
| Gate Resistance   | $R_g$                       | $V_{GS} = 15\text{mV}, V_{DS} = 0V, f = 1\text{MHz}$          |        | 4.5  |           | $\Omega$         |
| Total Gate Charge <sup>1,2</sup>  | $Q_g(V_{GS}=10V)$           | $V_{DS} = -15V, V_{GS} = -10V, I_D = -8A$                     |        | 20.3 |           | nC               |
|   | $Q_g(V_{GS}=4.5V)$          |   |        | 9.8  |           |                  |
| Gate-Source Charge <sup>1,2</sup>   | $Q_{gs}$                    |   |        | 3.2  |           |                  |
| Gate-Drain Charge <sup>1,2</sup>  | $Q_{gd}$                    |   |        | 4.9  |           |                  |
| Turn-On Delay Time <sup>1,2</sup>   | $t_{d(on)}$                 | $V_{DS} = -15V, I_D = -1A, V_{GS} = -10V, R_{GS} = 2.7\Omega$ |        | 10   |           | nS               |
| Rise Time <sup>1,2</sup>  | $t_r$                       |   |        | 8    |           |                  |
| Turn-Off Delay Time <sup>1,2</sup>  | $t_{d(off)}$                |   |        | 25   |           |                  |
| Fall Time <sup>1,2</sup>  | $t_f$                       |   |        | 6    |           |                  |
| SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ ) |                             |   |        |      |           |                  |
| Continuous Current  | $I_S$                       | $I_F = I_S, V_{GS} = 0V$                                      |        |      | -2.3      | A                |
| Pulsed Current <sup>3</sup>   | $I_{SM}$                    |   |        |      | -9.2      |                  |
| Forward Voltage <sup>1</sup>  | $V_{SD}$                    | $I_F = I_S, V_{GS} = 0V$                                      |        |      | -1.2      | V                |
| Reverse Recovery Time   | $t_{rr}$                    | $I_F = I_S, dI_F/dt = 100\text{A}/\mu\text{s}$                |        | 32   |           | nS               |
| Reverse Recovery Charge   | $Q_{rr}$                    |   |        | 26   |           |                  |

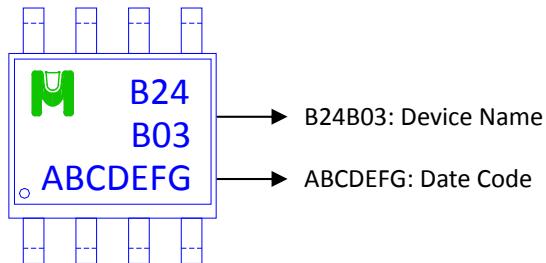
<sup>1</sup>Pulse test : Pulse Width  $\leq$  300  $\mu$ sec, Duty Cycle  $\leq$  2%.

<sup>2</sup>Independent of operating temperature.

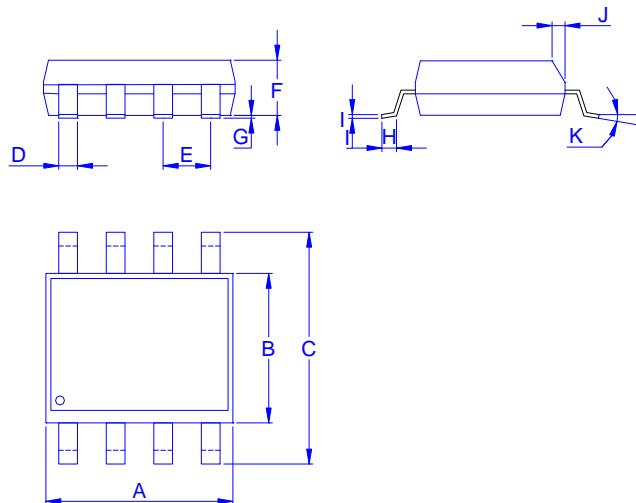
<sup>3</sup>Pulse width limited by maximum junction temperature.

#### Ordering & Marking Information:

Device Name: EMB24B03G for SOP-8



#### Outline Drawing



#### Dimension in mm

| Dimension | A    | B    | C    | D    | E    | F    | G    | H    | I    | J    | K  |
|-----------|------|------|------|------|------|------|------|------|------|------|----|
| in.       | 4.70 | 3.70 | 5.80 | 0.33 |      | 1.20 | 0.08 | 0.40 | 0.19 | 0.25 | 0° |
| Typ.      |      |      |      |      | 1.27 |      |      |      |      |      |    |
| Max.      | 5.10 | 4.10 | 6.20 | 0.51 |      | 1.62 | 0.28 | 0.83 | 0.26 | 0.50 | 8° |

